

### OSFP-QDD-CVR-C

MSA and TAA 800GBase-Converter OSFP Transceiver (OSFP to QSFP-DD Converter)

#### **Features:**

- Data Rates: 56Gbps Per Lane or 112Gbps Per Lane
- Compliant with IEEE802.3ck (800GBASE-CR8, 400GBASE-CR4)
- Compliant with IEEE802.3cd (400GBASE-CR8, 200GBASE-CR4)
- Compliant with IEEE802.3bj (200GBASE-CR8, 100GBASE-CR4)
- Connector Compliant with OSFP Octal Small Form Factor Pluggable Module OSFP MSA and QSFP-DD MSA Standard
- Standard Power Consumption: 16W
- Low-Power Consumption: 0.5W
- Operating Temperature: 0 to 70 Celsius
- RoHS Compliant and Lead-Free



• 800GBase Ethernet



This MSA Compliant OSFP to QSFP-DD converter provides conversion from OSFP to QSFP-DD form factors. It is built to MSA standards and is uniquely serialized and data-traffic and application tested to ensure that they will integrate into your network seamlessly. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This converter is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

ProLabs' transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open internaltional trade. TAA requires that the U.S. Government may acquire only "U.S.-made or designated country end products.")





**Absolute Maximum Ratings** 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Operating Temperature	Тс	0		70	°C	
Storage Temperature	Tstg	0		70	°C	
Relative Humidity (Non-Condensing)	RH			85	%	
Supply Voltage	Vcc	3.15		3.45	V	
Power Consumption	PC			0.5	W	
Characteristic Impedance	Im	90		110	Ω	
Data Rate	DR	25		112	Gbps	

# **OSFP Pin Descriptions**

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2+	Non-Inverted Transmitter Data. 3		
3	CML-I	Tx2-	Inverted Transmitter Data. 3		
4		GND	Module Ground.	1	1
5	CML-I	Tx4+	Non-Inverted Transmitter Data.	3	
6	CML-I	Tx4-	Inverted Transmitter Data.	3	
7		GND	Module Ground.	1	1
8	CML-I	Tx6+	Non-Inverted Transmitter Data.	3	
9	CML-I	Tx6-	Inverted Transmitter Data.	3	
10		GND	Module Ground.	1	1
11	CML-I	Tx8+	Non-Inverted Transmitter Data.	3	
12	CML-I	Tx8-	Inverted Transmitter Data.	3	
13		GND	Module Ground.	1	1
14	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3	2
15		Vcc	+3.3V Power.	2	
16		Vcc	+3.3V Power.	2	
17	Multi-Level	LPWn/PRSn	Low-Power Mode/Module Present.	3	
18		GND	Module Ground.	1	1
19	CML-O	Rx7-	Inverted Receiver Data.	3	
20	CML-O	Rx7+	Non-Inverted Receiver Data.	3	
21		GND	Module Ground.	1	1
22	CML-O	Rx5-	Inverted Receiver Data.	3	
23	CML-O	Rx5+	Non-Inverted Receiver Data.	3	
24		GND	Module Ground.	1	1

25	CML-O	Rx3-	Inverted Receiver Data.	3	
26	CML-O	Rx3+	Non-Inverted Receiver Data.	3	
27		GND	Module Ground.	1	1
28	CML-O	Rx1-	Inverted Receiver Data.	3	
29	CML-O	Rx1+	Non-Inverted Receiver Data.		
30		GND	Module Ground.		1
31		GND	Module Ground.	1	1
32	CML-O	Rx2+	Non-Inverted Receiver Data.	3	
33	CML-O	Rx2-	Inverted Receiver Data.	3	
34		GND	Module Ground.	1	1
35	CML-O	Rx4+	Non-Inverted Receiver Data.	3	
36	CML-O	Rx4-	Inverted Receiver Data.	3	
37		GND	Module Ground.	1	1
38	CML-O	Rx6+	Non-Inverted Receiver Data.	3	
39	CML-O	Rx6-	Inverted Receiver Data.	3	
40		GND	Module Ground.	1	1
41	CML-O	Rx8+	Non-Inverted Receiver Data.	3	
42	CML-O	Rx8-	Inverted Receiver Data.	3	
43		GND	Module Ground.	1	1
44	Multi-Level	INT/RSTn	Module Input/Module Reset.	3	
45		Vcc	+3.3V Power.	2	
46		Vcc	+3.3V Power.	2	
47	LVCMOS-I/O	SCL	2-Wire Serial interface Data.	3	2
48		GND	Module Ground.	1	1
49	CML-I	Тх7-	Inverted Transmitter Data.	3	
50	CML-I	Tx7+	Non-Inverted Transmitter Data.	3	
51		GND	Module Ground.	1	1
52	CML-I	Tx5-	Inverted Transmitter Data.	3	
53	CML-I	Tx5+	Non-Inverted Transmitter Data.	3	
54		GND	Module Ground.	1	1
55	CML-I	Tx3-	Inverted Transmitter Data.	3	
56	CML-I	Tx3+	Non-Inverted Transmitter Data.	3	
57		GND	Module Ground.	1	1
58	CML-I	Tx1-	Inverted Transmitter Data.	3	
59	CML-I	Tx1+	Non-Inverted Transmitter Data.	3	
60		GND	Module Ground.	1	1

## **Notes:**

- 1. OSFP uses common ground (GND) for all signals and supply (power). All are common within the OSFP module, and all module voltages are referenced to this potential unless otherwise noted.
- 2. Open-drain with pull-up resistor on the host.

# **Electrical Pad Layout**

Top Side (viewed from top) Bottom Side (viewed from bottom) 60 GND GND 1 59 TX1p TX2p 2 58 TX1n TX2n 57 GND GND 4 56 ТХ3р ТХ4р 5 55 TX3n TX4n 6 54 GND GND 7 53 ТХ5р ТХ6р 8 52 TX5n ---- Module Card Edge TX6n 9 51 GND GND 10 50 ТХ8р 11 TX7p 49 TX7n TX8n 12 48 GND GND 13 47 SDA SCL 14 46 VCC VCC 15 45 VCC VCC 16 INT/RSTn LPWn/PRSn 44 17 43 GND GND 18 42 RX8n RX7n 19 41 RX8p RX7p 20 40 GND GND 21 39 RX6n RX5n 22 38 RX6p RX5p 23 37 GND GND 24 25 36 RX4n RX3n RX3p 35 RX4p 26 34 GND GND 27 28 33 RX2n RX1n 32 RX1p 29 RX2p 31 GND 30

# **QSFP-DD Pin Descriptions**

Pin	Logic	Symbol	Name/Description		Notes
1		GND	Module Ground.	1B	1
2	CML-I	Tx2-	Inverted Transmitter Data Input.	3B	
3	CML-I	Tx2+	Non-Inverted Transmitter Data Input.	3B	
4		GND	Module Ground.	1B	1
5	CML-I	Tx4-	Inverted Transmitter Data Input.	3B	
6	CML-I	Tx4+	Non-Inverted Transmitter Data Input.	3B	
7		GND	Module Ground.	1B	1
8	LVTTL-I	ModSelL	Module Select.	3B	
9	LVTTL-I	ResetL	Module Reset.	3B	
10		VccRx	+3.3V Receiver Power Supply.	2B	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3B	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3B	
13		GND	Module Ground.	1B	1
14	CML-O	Rx3+	Non-Inverted Receiver Data Output.	3B	
15	CML-O	Rx3-	Inverted Receiver Data Output.	3B	
16		GND	Module Ground.	1B	1
17	CML-O	Rx1+	Non-Inverted Receiver Data Output.	3B	
18	CML-O	Rx1-	Inverted Receiver Data Output.	3B	
19		GND	Module Ground.	1B	1
20		GND	Module Ground.	1B	1
21	CML-O	Rx2-	Inverted Receiver Data Output.	3B	
22	CML-O	Rx2+	Non-Inverted Receiver Data Output.	3B	
23		GND	Module Ground.	1B	1
24	CML-O	Rx4-	Inverted Receiver Data Output.	3B	
25	CML-O	Rx4+	Non-Inverted Receiver Data Output.	3B	
26		GND	Module Ground.	1B	1
27	LVTTL-O	ModPrsL	Module Present.	3B	
28	LVTTL-O	IntL	Interrupt.	3B	
29		VccTx	+3.3V Transmitter Power Supply.	2B	2
30		Vcc1	+3.3V Power Supply.	2B	2
31	LVTTL-I	LPMode	Low-Power Mode.	3B	
32		GND	Module Ground.	1B	1
33	CML-I	Tx3+	Non-Inverted Transmitter Data Input.	3B	
34	CML-I	Tx3-	Inverted Transmitter Data Input.	3B	
35		GND	Module Ground.	1B	1
36	CML-I	Tx1+	Non-Inverted Transmitter Data Input.	3B	
37	CML-I	Tx1-	Inverted Transmitter Data Input.	3B	
38		GND	Module Ground.	1B	1
39		GND	Module Ground.	1A	1
40	CML-I	Tx6-	Inverted Transmitter Data Input.	3A	

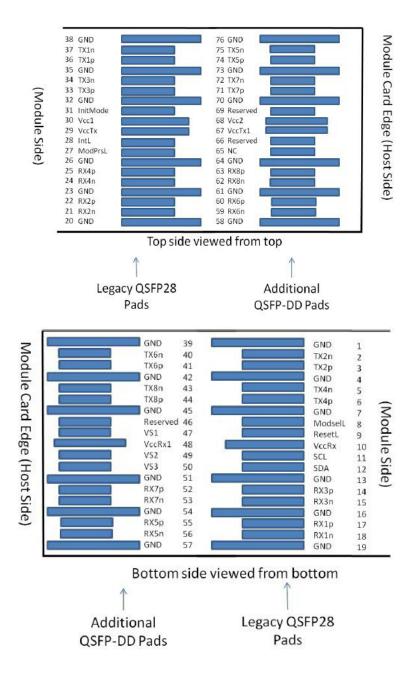
41	CML-I	Tx6+	Non-Inverted Transmitter Data Input.	3A	
42		GND	Module Ground.	1A	1
43	CML-I	Tx8-	Inverted Transmitter Data Input.	3A	
44	CML-I	Tx8+	Non-Inverted Transmitter Data Input.	3A	
45		GND	Module Ground.	1A	1
46		Reserved	For Future Use.	3A	3
47		VS1	Module Vendor-Specific 1.	3A	3
48		VccRx1	+3.3V Receiver Power Supply.	2A	2
49		VS2	Module Vendor-Specific 2.	3A	3
50		VS3	Module Vendor-Specific 3.	3A	3
51		GND	Module Ground.	1A	1
52	CML-O	Rx7+	Non-Inverted Receiver Data Output.	3A	
53	CML-O	Rx7-	Inverted Receiver Data Output.	3A	
54		GND	Module Ground.	1A	1
55	CML-O	Rx5+	Non-Inverted Receiver Data Output.	3A	
56	CML-O	Rx5-	Inverted Receiver Data Output.	3A	
57		GND	Module Ground.	1A	1
58		GND	Module Ground.	1A	1
59	CML-O	Rx6-	Inverted Receiver Data Output.	3A	
60	CML-O	Rx6+	Non-Inverted Receiver Data Output.	3A	
61		GND	Module Ground.	1A	1
62	CML-O	Rx8-	Inverted Receiver Data Output.	3A	
63	CML-O	Rx8+	Non-Inverted Receiver Data Output.	3A	
64		GND	Module Ground.	1A	1
65		NC	Not Connected.	3A	3
66		Reserved	For Future Use.	3A	3
67		VccTx1	+3.3V Transmitter Power Supply.	2A	2
68		Vcc2	+3.3V Power Supply.	2A	2
69		Reserved	For Future Use.	3A	3
70		GND	Module Ground.	1A	1
71	CML-I	Tx7+	Non-Inverted Transmitter Data Input.	3A	
72	CML-I	Тх7-	Inverted Transmitter Data Input.	3A	
73		GND	Module Ground.	1A	1
74	CML-I	Tx5+	Non-Inverted Transmitter Data Input.	3A	
75	CML-I	Tx5-	Inverted Transmitter Data Input.	3A	
76		GND	Module Ground.	1A	1

## Notes:

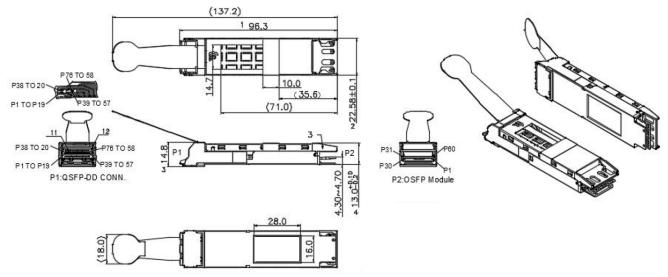
- 1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 shall be applied concurrently. VccRx, VccRx1, Vcc1,

- Vcc2, VccTx, and VccTx1 may be internally connected within the module in any combination. The connector Vcc pins are each rated for a maximum current of 1000mA.
- 3. All Vendor-Specific, Reserved, and Not Connected pins may be terminated with  $50\Omega$  to ground on the host. Pad 65 (Not Connected) shall be left unconnected within the module. Vendor-Specific and Reserved pads shall have an impedance to GND that is greater than  $10k\Omega$  and less than 100pF.
- 4. Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1A, 2A, 3A, 1B, 2B, and 3B. Contact sequence A will make, then break, contact with additional QSFP-DD pads. Sequence 1A, 1B will then occur simultaneously, followed by 2A, 2B, followed by 3A, 3B.

# **Electrical Pad Layout**



# **Mechanical Specifications**



#### **About ProLabs**

Our experience comes as standard; for over 15 years ProLabs has delivered optical connectivity solutions that give our customers freedom and choice through our ability to provide seamless interoperability. At the heart of our company is the ability to provide state-of-the-art optical transport and connectivity solutions that are compatible with over 90 optical switching and transport platforms.

## **Complete Portfolio of Network Solutions**

ProLabs is focused on innovations in optical transport and connectivity. The combination of our knowledge of optics and networking equipment enables ProLabs to be your single source for optical transport and connectivity solutions from 100Mb to 400G while providing innovative solutions that increase network efficiency. We provide the optical connectivity expertise that is compatible with and enhances your switching and transport equipment.

#### **Trusted Partner**

Customer service is our number one value. ProLabs has invested in people, labs and manufacturing capacity to ensure that you get immediate answers to your questions and compatible product when needed. With Engineering and Manufacturing offices in the U.K. and U.S. augmented by field offices throughout the U.S., U.K. and Asia, ProLabs is able to be our customers best advocate 24 hours a day.















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